

PCN Number:	20190816000	PCN Date:	Aug. 30, 2019
Title:	Datasheet for TMP61		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



TMP61

SBOS921B – DECEMBER 2018 – REVISED JULY 2019

Changes from Revision A (June 2019) to Revision B

Page

• Changed <i>Application</i> bullets	1
• Increased ESD CDM Rating	4
• Added Thermal Information for LPG Package	4
• Added 'Long Term Drift' spec for LPG package	5
• Changed polynomial equation	8
• Added equations for both DEC package and LPG packages	8
• Added transfer tables for the LPG package	9
• Changed <i>Layout Example</i> section	20

The datasheet number will be changing.

Device Family	Change From:	Change To:
TMP61	SBOS921A	SBOS921B

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TMP61>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

PTMP6131LPGM	TMP6131DECR	TMP6131DECT	TMP6131LPG
TMP6131LPGM			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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